

PerF±T[™]Power Transistor

FEATURES

- Ultra-low On-resistance
- Wettable Flank leads for Enhanced AOI
- 100% UIS and Rg tested
- 175°C Operating Junction Temperature
- RoHS Compliant
- Halogen-Free according to IEC 61249-2-21

PRODUCT SUMMARY				
PARAMETER		RAMETER VALUE		
$V_{ t DS}$		40	V	
R _{DS(on)} (max)	$V_{GS} = 10V$	4.3		
	$V_{GS} = 4.5V$	6	mΩ	
Q_{g}	$V_{GS} = 4.5V$	20	nC	



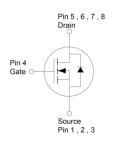




APPLICATIONS

- DC-DC Converters
- Solenoid and Motor Drivers
- Load Switch





Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	40	V
Gate-Source Voltage		V_{GS}	±16	V
Continuous Drain Current, Silicon limited	$T_C = 25^{\circ}C$	I_{D}	113	Α
	$T_C = 25$ °C	I _D	54	
Continuous Drain Current (Note 1)	$T_C = 100$ °C		54	А
	T _A = 25°C		20	
Pulsed Drain Current		I _{DM}	216	А
Single Pulse Avalanche Current (Note 2)		I _{AS}	25.6	А
Single Pulse Avalanche Energy (Note 2)		E _{AS}	98.3	mJ
Total Power Dissipation	T _C = 25°C	P _D	100	W
	$T_C = 125$ °C		33	VV
Operating Junction and Storage Temperature Range		T_J,T_STG	- 55 to +175	°C

THERMAL RESISTANCE				
PARAMETER	SYMBOL	MAXIMUM	UNIT	
Thermal Resistance – Junction to Case	R _{eJC}	1.5	°C/W	
Thermal Resistance – Junction to Ambient	$R_{\Theta JA}$	50	°C/W	

Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JC}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design.

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PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_D = 1mA$	BV _{DSS}	40			V
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	1.4	1.8	2.2	V
Gate-Source Leakage Current	$V_{GS} = \pm 16V, V_{DS} = 0V$	I _{GSS}	-		±100	nA
Drain-Source Leakage Current	$V_{GS} = 0V$, $V_{DS} = 40V$	I _{DSS}	1		1	μA
Drain-Source On-State Resistance (Note 3)	$V_{GS} = 10V, I_D = 27A$		-	2.9	4.3	mΩ
	$V_{GS} = 4.5V, I_D = 27A$	R _{DS(on)}	-	3.7	6	
Forward Transconductance (Note 3)	$V_{DS} = 10V, I_{D} = 10A$	g fs	1	83		s
Dynamic						
Total Gate Charge	$V_{GS} = 4.5V, V_{DS} = 25V,$ $I_D = 20A$	Q_{α}		20		
Total Gate Charge	$V_{GS} = 10V, V_{DS} = 25V,$ $I_{D} = 20A$	Q_g		42		nC
Gate-Source Charge		Q_gs		8		
Gate-Drain Charge		Q_gd		6		
Input Capacitance	N 0V V 05V	C _{iss}		2480		
Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1.0MHz	C _{oss}		476		pF
Reverse Transfer Capacitance	1 – 1.0WH12	C _{rss}		37		
Gate Resistance	f = 1.0MHz	R_g		0.7		Ω
Switching (Note 4)						
Turn-On Delay Time		t _{d(on)}		10		
Rise Time	$V_{GS} = 10V, V_{DS} = 25V,$ $I_{D} = 20A, R_{G} = 0.7\Omega$	t _r		59		
Turn-Off Delay Time		t _{d(off)}	1	27		ns
Fall Time		t _f	-	13		
Source-Drain Diode						
Diode Forward Voltage (Note 3)	$V_{GS} = 0V, I_{S} = 27A$	V _{SD}			1.1	V
Reverse Recovery Time	I _S = 20A,	t _{rr}		37		ns
Reverse Recovery Charge	di/dt = 100A/µs	Q_{rr}		31		nC

Notes:

- 1. Package current limit.
- 2. L = 0.3mH, $V_{GS} = 10V$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$.
- 3. Pulse test: Pulse Width \leq 300µs, duty cycle \leq 2%.
- 4. Switching time is essentially independent of operating temperature.

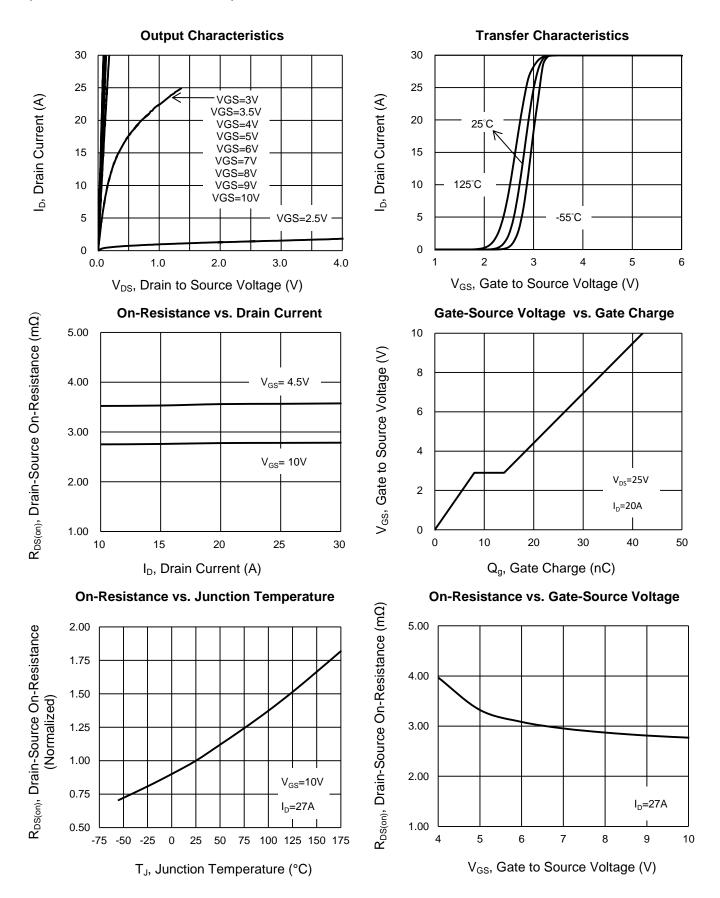
ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSM043NH04LCR RLG	PDFN56U	2,500pcs / 13" Reel



CHARACTERISTICS CURVES

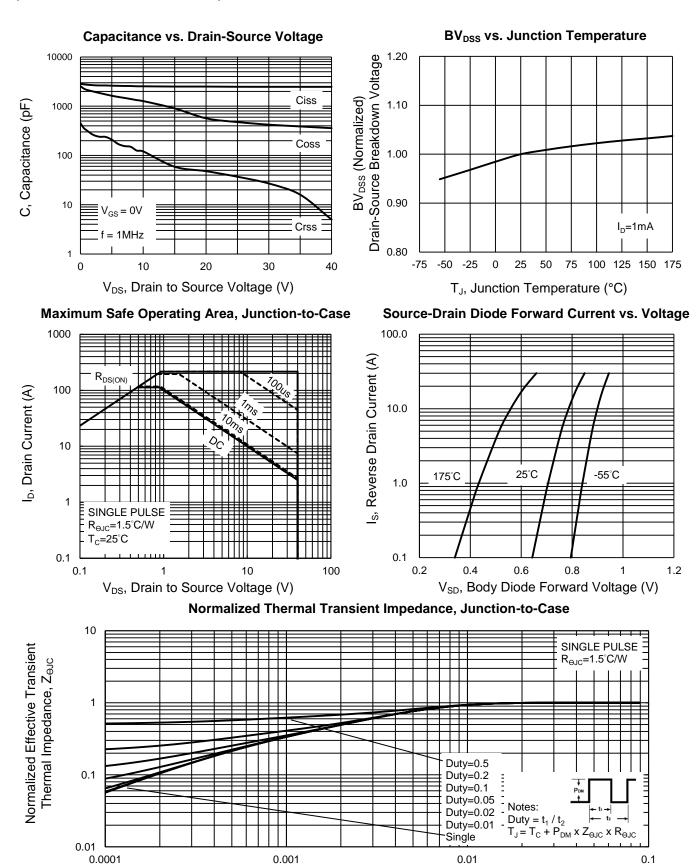
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$





CHARACTERISTICS CURVES

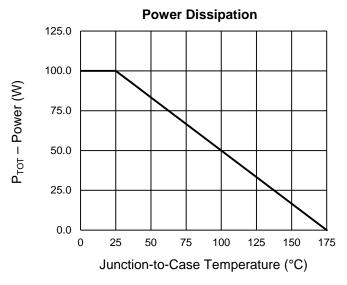
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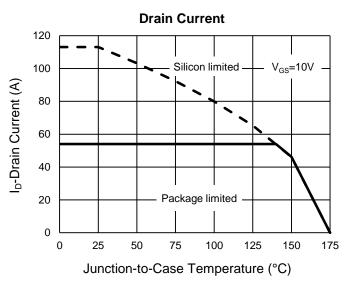


t, Square Wave Pulse Duration (sec)

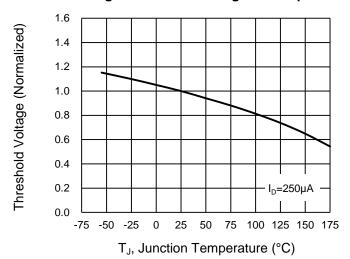
CHARACTERISTICS CURVES

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Normalized gate threshold voltage vs Temperature



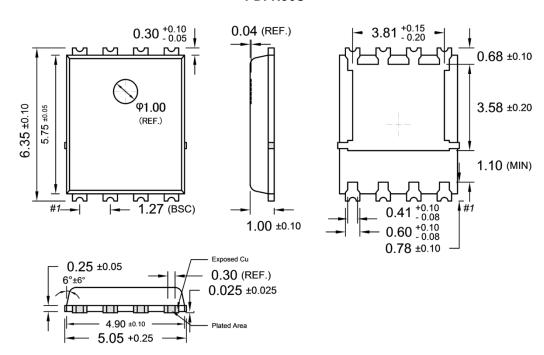
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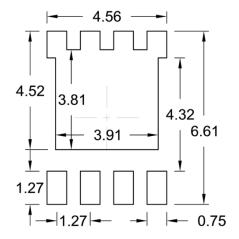


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

PDFN56U



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



Y = Year Code

WW = Week Code $(01\sim52)$

L = Lot Code (1~9,A~Z)

F = Factory Code



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